

### Bluetooth 5 Class 1 UART HCI Modules





BT860-SA

The BT86x series of UART HCI modules leverage the **Cypress CYW20704 A2** chipset to provide exceptionally low power consumption with outstanding range for OEMs needing both **Classic Bluetooth** and **Bluetooth Low Energy** support. The **Bluetooth v4.2** core specification shortens your development time and provides enhanced throughput, security and privacy.

The BT860 modules are ideal when designers need both performance and minimum size. For maximum flexibility in integration, they support a **host UART** interface, **I**<sup>2</sup>**S** and **PCM** audio interfaces, **GPIO**, and Cypress'GCI **coexistence** (2-Wire). The modules provide excellent RF performance and identical footprint options for integrated antenna or an external antenna via a trace pin.

These modules present a Bluetooth standard HCI interface with support for Linux / Android and Embedded Bluetooth software stacks for operating system backed devices. Additionally, we have partnered with Searan for support of their ultra small, flexible 'dotstack' platform for embedded Cortex M3 and M4 implementations.



BT860-ST

- Bluetooth v4.2 Dual Mode BR / EDR / LE
  - Classic Bluetooth
  - Bluetooth Low Energy (BLE)
  - Compact Footprint As small as 8.5x13 mm
- Class 1 Output up to 8 dBm
- UART Host interface
- GPIO, GCI, I<sup>2</sup>S and PCM
- Industrial Operating Temp: -30° to +85°C
- Bluetooth SIG approved Hardware Controller Subsystem
- International regulatory approvals FCC, IC, CE, RCM, & Japan approvals
- Broad BT Stack Support Linux, Android, Embedded
- Fully-Featured Development Kit Low cost kit for prototyping/debugging/integration testing to speed development time

#### FEATURES AT A GLANCE



# OUTSTANDING RF PERFORMANCE IN A TINY FOOTPRINT

Class I +8dBm output power in an  $8.5\,x\,13$  mm package means no need to compromise one for the other



#### **EVEN MORE WAYS TO DEVELOP**

Wide array of Operating System support, as well as embedded MCU support for Searan's flexible DotStack platform give you even more design choices



# BROAD CERTIFICATION AND INTERNATIONAL APPROVALS

Certifications and approvals for FCC (USA), IC (Canada), ETSI (Europe), Giteki (Japan), RCM (AUS/NZ), Bluetooth SIG



# PERSONAL SUPPORT FROM DESIGN TO MANUFACTURE

Industry-recognized integration and support organization dedicated to reducing your time to market

#### **APPLICATION AREAS**



AIDC Products / Barcode Scanners



**Industrial Cable Replacement** 



**IoT Platforms** 



**Medical Devices** 



**Automotive Diagnostics** 



### SHARED SPECIFICATIONS

CATEGORIES	FEATURE	IMPLEMENTATION
Wireless Specification	Bluetooth®	V4.2 Dual Mode – BR / EDR / LE
	Frequency	2.402 – 2.480 GHz
	Max. Transmit Power	Class 1
		+8 dBm from antenna
		+8 dBm from trace pin
	Receive Sensitivity	-94 dBm
	Range	Circa 100 meters
	Data Rates	Up to 3 Mbps (over the air)
Host Interface	UART	UART Interface
Operational Modes	HCI	Host Controller Interface over UART
Coexistence	802.11 (Wi-Fi)	2-wire Cypress Global Coexistence Interface (GCI)
Supply Voltage	Supply	3.0V – 3.6V (BT860-SA and BT860-ST)
Power Consumption	Current	Tx Max. < 55 mA
		Sleep < 120 us
Antenna Option	Internal	Multilayer Ceramic (BT860-SA)
	External	SMT Pad (BT860-ST)
Physical	Dimensions	8.5 x 13 x 2.2 mm (BT860-SA)
		8.5 x 13 x 1.9 mm (BT860-ST)
Environmental	Operating	-30° to +85°C
	Storage	-40° to +85°C
Miscellaneous	Lead Free	Lead-free and RoHS compliant
	Warranty	One-Year Warranty
Approvals	Bluetooth®	Hardware Controller Subsystem
	FCC / IC / CE / RCM / Giteki	All BT86x series

## **ORDERING INFORMATION**

BT860-SA	BT V4.2 Dual Mode UART HCI Module (Integrated Antenna)	
BT860-ST	BT V4.2 Dual Mode UART HCI Module (SMT Pad for External Antenna)	
DVK-BT860-SA	Development Kit for BT860-SA Module	
DVK-BT860-ST	Development Kit for BT860-ST Module	